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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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Kie Y. Ahn

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EXAMINER

LINDSAY JR, WALTER LEE

ART UNIT

PAPER NUMBER

2812

DATE MAILED: 08/12/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

09/944,981

Applicant(s)

AHN ET AL.

Examiner

Walter L. Lindsay, Jr.

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☐ Responsive to communication(s) filed on ____.
- 2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-29 and 54-60 is/are pending in the application.
- 4a) Of the above claim(s) ____ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 9-13 is/are allowed.
- 6) ☒ Claim(s) 1-7, 14-20, 22-28, 54-56 and 58-60 is/are rejected.
- 7) ☒ Claim(s) 8, 21, 29 and 57 is/are objected to.
- 8) ☐ Claim(s) ____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on ____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on ____ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. ____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-1449) Paper No(s) ____
- 4) ☐ Interview Summary (PTO-413) Paper No(s). ____
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other:

DETAILED ACTION

Claim Rejections - 35 USC § 103

1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

2. Claims 1-7, 14-20, 22-28, 54-56 and 58-60 rejected under 35 U.S.C. 103(a) as being unpatentable over Maiti et al U.S. Patent No. 6,020,024 in view of Saito et al U.S. Patent No. 4,797,593.

The main subject of the present invention is the formation of a rare earth metal that is deposited by evaporation and then oxidized. The combination of Maiti and Saito are applied and cover these issues.

Maiti discloses the use of a metal oxide layer as a gate layer.

FIG. 2 illustrates the formation of a metal oxide gate layer 16. In one embodiment, the metal oxide gate dielectric layer 16 is formed by the deposition 18 of a metal film followed by an oxidizing ambient. In another embodiment, the environment 18 would be a chemical vapor deposition (CVD) of a metal oxide followed by an oxygen anneal to reduce oxygen vacancies in the metal oxide film. Such CVD metal oxide depositions or metal sputtering followed by O₂ anneal would include the formation of tantalum pentoxide, titanium dioxide (TiO₂), yttrium oxide (Y₂O₃), niobium oxide (Nb₂O₅), zirconium oxide (ZrO₂), hafnium oxide (HfO₂), lead zirconium titanate (PZT), barium strontium titanate (BST), calcium

oxide (CaO), beryllium oxide (BeO), magnesium oxide (MgO), and strontium bismuth titanate (SBT). In addition to the deposition of metal oxide gate dielectric layer using CVD, it is possible to deposit a metal layer by sputtering and subsequently perform an oxidation step on the deposited layer and also perform CVD of a metallic oxide to form a composite metal layer. In this approach, any of the previously listed metals, tantalum, titanium, yttrium, niobium, zirconium or hafnium, could conceivably be deposited in metal form forming a layer and subsequently oxidized during an annealing step (col. 3 lines 30-52).

The metal oxide gate layer 16 will be a high-k dielectric layer. Typical permittivity values, depending upon the metal or alloy used to form the oxide layer 16, will be in the range of $k=7.0$ through 1500. Where tantalum pentoxide is used, a permittivity k or ϵ of approximately 25 is obtained. Therefore, where tantalum pentoxide forms the metal oxide gate layer, it can have a thickness of approximately 100 angstroms and have the same equivalent SiO_2 thickness of 20 angstroms for a conventional gate oxide layer. The 100 angstroms thickness of the tantalum pentoxide gate would reduce the amount of leakage current across the gate dielectric structure while still improving the overall performance of the semiconductor structure by maintaining or reducing the effective gate oxide thickness (EOT). Following the formation of the high-k dielectric layer 16, an oxidizing (O_2) anneal step, or other anneal process for improving the molecular quality, can be performed in order to reduce defects in of the dielectric layer (col. 3 line 64 –col. 4 line 14).

Saito discusses a method of depositing a metal and metal oxide layer through evaporation.

The rare earth metal oxide layer 5a or the rare earth metal layer 5b is formed by an electron beam evaporation method or a sputtering method prior to formation of the electron-emissive layer 2 (col. 9 lines 56-64).

Given the teaching of the references, it would have been obvious to determine the optimum thickness, temperature as well as condition of delivery of the layers involved. See *In re Aller*, Lacey and Hall (10 USPQ 233-237) It is not inventive to discover optimum or workable ranges by routine experimentation. Note that the specification contains no disclosure of either the critical nature of the claimed ranges or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. *In re Woodruff*, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to use the knowledge of Saito that rare earth metals can be deposited by evaporation in the primary reference of Maiti to deposit the metal oxide gate layer in order to gain the advantage of the fact that a metal oxide layer can be formed to a thickness greater than a silicon oxide layer but maintains the advantages of a thinner layer of silicon oxide.

Allowabl Subject Matter

3. Claims 9-13 are allowed.

4. Claims 8, 21, 29 and 57 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

The following is an examiner's statement of reasons for allowance: the prior art, either singly or in combination fails to anticipate or render obvious, the limitations of:

The process of evaporation combined with the oxidizing the metal layer in a krypton(Kr)/oxygen (O₂) mixed plasma process to form a metal oxide layer on the body region.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Hong et al. U. S. Patent No. 6,404,027 (col. 3 lines 25-55) is pertinent to the applicant's disclosure and should also be considered.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Walter L. Lindsay, Jr. whose telephone number is (703) 306-5727. The examiner can normally be reached on Monday-Thursday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John F Niebling can be reached on (703) 308-3325. The fax phone

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numbers for the organization where this application or proceeding is assigned are (703) 308-7724 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 308-3325.

WLL

Walter L. Lindsay

August 8, 2002

John F. Nisbling
Supervisory Patent Examiner
Technology Center 2800